Vishay Sfernice

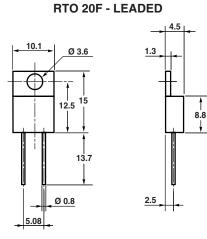


Power Resistors Thick Film Technology



The well known TO 220 package is compact and easy to mount.

DIMENSIONS in millimeters



Tolerance unless otherwise specified: ± 0.4 mm

MECHANICAL SPECIFICATIONS

Mechanical Protection	
Resistive Element	
Connections	
Weight	

Insulated Case
Thick Film
Tinned copper
2.2 g max.

DIMENSIONS

Standard Package

TO 220 Insulated case

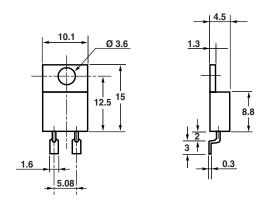
ENVIRONMENTAL SPECIFICATIONS

Temperature Range	- 55 °C to + 155 °C
Climatic Category	55/155/56
Sealing	Sealed container Solder immersion
Flammability	IEC 60695-11-5 2 applications 30 s seperated by 60 s

FEATURES

- 20 W at 25 °C Heatsink Mounted
- High Power Dissipation to size ratio
- Wide Resistance Range from 0.01 Ω to 1 $M\Omega$
- Negligible Inductance
- Easy Mounting
- TO 220 package: Compact and easy to mount
- Two versions of this thick film resistor are available:
- A Radial Leaded version for PCB Mounting
- A Flat Lead version for Surface Mounting

RTO 20C - FOR SURFACE MOUNTING



• Only for RTO 20 version C = during surface mount soldering temperature profile must not cause the metal tab of this device to exceed 220 °C.

ELECTRICAL SPECIFICATIONS			
Resistance Range	0.010 Ω to 1 M Ω serie E24		
Tolerances (Standard)	± 1 % to ± 10 %		
Dissipation and Associated:	Onto a heatsink		
Thermal Resistance and Nominal Power	20 W at + 25 °C R _{TH} (j-c): 6.5 °C/W free air: 2 W at + 25 °C		
Temperature Coefficient	See Performance table		
Standard (- 55 °C; + 150 °C)	± 150 ppm/°C		
Limiting Element Voltage	250 V		
Dielectric Strength MIL STD 202	2000 V _{RMS} - 1 min - 10 mA Max (Between Terminals and Heatsink)		
Insulation Resistance	$\geq 10^6 \text{ M}\Omega$		
Inductance	≤ 0.1 μH		
Critical Resistance	3.12 kΩ		

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PERFORMANCE					
TESTS	CONDITIONS	TYPICAL DRIFTS			
Momentary Overload	EN 60115-1 2 Pr for R < 2 Ω 1.6 Pr for R \geq 2 Ω Us < 1.5 UL	± (0.25 % + 0.005 Ω)			
Rapid Temperature Change	EN 60115-1/60068-2-14 5 cycles - 55 °C to + 155 °C	± (0.5 % + 0.005 Ω)			
Load Life	EN 60115-1 1000 h Pr at + 25 °C	± (1 % + 0.005 Ω)			
Humidity (Steady State)	EN 60115-1 56 days R.H. 95 %	± (0.5 % + 0.005 Ω)			
High Temperature Exposure	NF EN 140 000 1000 h - 40 % Pr at + 100 °C	± (0.5 % + 0.005 Ω)			
Vibration	MIL STD 202, Method 204 C Test D	± (0.2 % + 0.005 Ω)			
Terminal Strength	MIL STD 202, Method 211 Test A1	± (0.2 % + 0.005 Ω)			
Shock	IEC 60115-1 IEC 60068-2-27 Saw tooth: 100 g/6 ms	± (0.5 % + 0.005 Ω)			

SPECIAL FEATURES					
Resistance Values	≥ 0.01 ≥ 0.015 ≥ 0.1			≥ 0.5	
Tolerances	± 1 % at ± 10 %				
Typical Temperature Coefficient Range (- 55 °C/+ 155 °C)	± 900 ppm/°C	± 700 ppm/°C	± 250 ppm/°C	± 150 ppm/°C	

Note: For very low ohmic values, TCR for information

CHOICE OF THE HEATSINK

The user must choose according to the working conditions of the component (power, room temperature).

Maximum working temperature must not exceed 155 °C. The dissipated power is simply calculated by the following ratio:

$$\mathsf{P} = \frac{\Delta \mathsf{T}}{[\mathsf{R}_{\mathsf{TH}} (j\text{-}\mathsf{c}) + \mathsf{R}_{\mathsf{TH}} (\mathsf{c}\text{-}\mathsf{a})]}^{(1)}$$

P: expressed in W

 ΔT : difference between maximum working temperature and room temperature

- R_{TH}: (j-c): thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal resistance of the component: (Special Features Table)
- R_{TH}: (c-a): thermal resistance value measured between outer side of the resistor and room temperature. It is the thermal resistance of the heatsink itself (type, shape) and the quality of the fastening device.

Example:

 R_{TH} : (c-a) for RTO 20 power rating 10 W at ambient temperature + 25 $^\circ C$

Thermal resistance R_{TH} (j-c): 6.5 °C/W

Considering equation (1) we have:

 $\Delta T = 155 \ ^{\circ}C - 25 \ ^{\circ}C = 130 \ ^{\circ}C$

$$R_{TH}$$
 (j-c) + R_{TH} (c-a) = $\frac{\Delta T}{P}$ = $\frac{130}{10}$ = 13 °C/W
 R_{TH} (c-a) = 13 °C/W - 6.5 °C/W = 6.5 °C/W

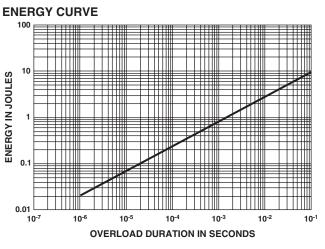
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OVERLOADS

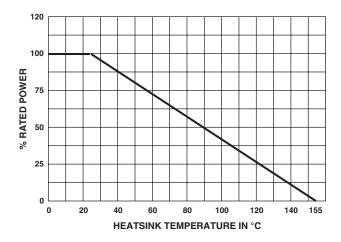
In any case the applied voltage must be lower than the maximum overload voltage of 375 V. The values indicated on the graph below are applicable to resistors in air or mounted onto a heatsink.



POWER RATING CHART

The temperature of the heatsink should be maintained within the limits specified.

To improve the thermal conductivity, surfaces in contact should be coated with a silicone grease and the torque applied on the screw for tightening should be around 1 Nm. Spring clip can also be used to mount the component on an heatsink (ex: Kunze, clip KU4-498).



MARKING

Model, Style, Resistance Value (in Ω), Tolerance (in %), Manufacturing Date, VISHAY trademark.

GING							
) units							
RING II	NFORMATION						
20	F	U68	5 %	ХХХ	TU50	e3	
STYLE	CONNECTIONS	RESISTANCE VALUE	TOLERANCE	CUSTOM DESIGN	N PACKAGING	LEAD (Pb)-FREE	
	F: Radial Leads C: Surface Mount		± 1 % ± 2 % ± 5 % ± 10 %	Optional on request: special TCR, shape etc.			
SAP PART NUMBERING GUIDELINES							
020	F	R680	0	J	Т	e3	
STYL	E CONNECTIO	ONS RESISTANCE	E VALUE	TOLERANCE	PACKAGING	LEAD (Pb)-FREE	
	o units RING II 20 STYLE ART NU 020	20 units RING INFORMATION 20 F STYLE CONNECTIONS F: Radial Leads C: Surface Mount ART NUMBERING GU 020 F	20 units 20 F U68 STYLE CONNECTIONS RESISTANCE VALUE F: Radial Leads C: Surface Mount C: Surface Mount ART NUMBERING GUIDELINES 020 F R680	20 units 20 F U68 5 % STYLE CONNECTIONS RESISTANCE VALUE TOLERANCE F: Radial Leads ± 1 % ± 2 % ± 5 % C: Surface Mount ± 1 % ± 2 % ± 5 % ART NUMBERING GUIDELINES 020 F R6800	20 units 20 F U68 5 % xxx STYLE CONNECTIONS RESISTANCE VALUE TOLERANCE CUSTOM DESIGN F: Radial Leads ± 1 % Optional on request: C: Surface Mount ± 2 % special TCR, ± 10 % shape etc. shape etc. ART NUMBERING GUIDELINES 020 F R6800 J	Do units Structure Filter U68 5 % xxx TU50 20 F U68 5 % xxx TU50 STYLE CONNECTIONS RESISTANCE VALUE TOLERANCE CUSTOM DESIGN PACKAGING F: Radial Leads ± 1 % Optional 000000000000000000000000000000000000	



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